

FORMIKE ELECTRONIC CO.,LTD

PRDUCT SPECIFICATON

TFT LCD MODULE MODEL NO. : KWH022ST03-F02

- [] Preliminary Specification
 - [] Finally Specification

| CUSTOMER'S APPROVAL | | | | |
|---------------------|-------|--|--|--|
| SIGNATURE: | DATE: | | | |
| | | | | |
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• This specification is subject to change withouth notice.Please contact FORMIKE or it's representative before designing your product based on this specification.

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RECORDS OF REVISION

| REVISION NO. | REVISED DESCRIPTIONS | DATE |
|-----------------|-----------------------------|------------|
| 00 | Generation first version | 2009-05-29 |
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1 LCD MODULE PHYSICAL DATA

1.1 General Description

| Display Type | TFT/Transmissive |
|-----------------------|---------------------------------------|
| Viewing Direction | 6 o'clock |
| Connection Type | COG + FPC |
| Operation temperature | -20°C ~70°C |
| Storage temperature | -30 ℃ ~80℃ |
| Driving IC | HX8340B |
| MPU interface | 16-bit /8-bit Parallel 8080 interface |

1.2 <u>Mechanical Description</u>

| Item | Standard Value | Unit |
|----------------|-------------------------------------|------|
| Screen size | 2.0 | inch |
| Number of dots | 176RGB x 220 dots | - |
| LCM dimension | 40.90 (W) x 55.10(H) x 3.50(T) | mm |
| Active area | 34.85(W) x 43.56(H) | mm |
| Dot size | | mm |
| Approx. weight | TBD | g |
| Backlight | 3 chip white LED in Parallel | |



2 OUTLINE DIMENSIONS





3 BLOCK DIAGRAM



4 ABSOLUTE MAXIMUM RATINGS

| ITEM | SYMBOL | CONDITION | STA | UNIT | | |
|-------------------------|---------|-----------|------|------|-----|-------|
| | 0111202 | CONDITION | MIN | TYP | MAX | 01111 |
| Power Supply Voltage(1) | VDD | Ta=+25℃ | | 2.8 | 3.3 | V |
| Power Supply Voltage(2) | Iovec | Ta=+25℃ | | 2.8 | 3.3 | V |
| Power Supply Voltage(3) | Vci | Ta=+25℃ | | 2.8 | 3.3 | V |
| | | | | | | |
| Operating Temperature | Тор | | - 20 | - | +70 | °C |
| Storage Temperature | Tst | | - 30 | - | +80 | °C |

NOTE:

(1). If the module is used above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability

- (2). LCM should be grounded during handing LCM.
- (3). VDD>GND must be maintained.



5 ELECTRICAL CHARACTERISTICS

5.1 <u>DC Characteristics</u>

| ITEM | SYMBOL | CONDITIONS | DITIONS | | DARD VALUE | | |
|--------------------------------|---------|------------|----------|-----|------------|---|--|
| | | | MIN | TYP | MAX | | |
| Power Supply Voltage for Logic | VDD-GND | Ta=+25℃ | - | 2.8 | 3.3 | V | |
| Input High Voltage for LCD | VIH | _ | 0.8Iovcc | | Iovec | V | |
| Input Low Voltage for LCD | VIL | _ | Vss | | 0.2 Iovcc | V | |
| Output High Voltage for LCD | VOH | _ | 0.8Iovcc | | Iovec | V | |
| Output Low Voltage for LCD | VOL | _ | Vss | _ | 0.2 Iovcc | V | |

5.2 <u>Back-Light unit</u>

| PARAMETER | SYMBOL | REMARK | STAN | UNIT | | |
|--------------------------|-----------|---------------|-------|------|-------|-------|
| | | | MIN | TYP | MAX | |
| FORWARD VOLTAGE | VF | lf =45mA | 3.0 | 3.2 | 3.4 | V |
| LUMINOUS INTENSITY | lv | lf =45mA | 2800 | 3000 | - | cd/m2 |
| LUMINOUS TOLERANCE | lv-m | (min/max)/100 | - | 80 | - | % |
| | Х | lf_45mA | 0.260 | - | 0.300 | |
| CHROMATICITY COORDINATES | Y | II =45IIIA | 0.260 | - | 0.300 | |
| OPERATING TEMPERATURE | -20℃ ~70℃ | | | | | |
| STORAGE TEMPERATURE | -30℃ ~80℃ | | | | | |

5.3 AC Characteristics

Refer to HX8340B IC data sheet.



6 ELECTRO-OPTICAL CHARACTERISTICS

| Paramete | | Symbol | Condition | Min | Тур | Max | Unit | Remark |
|-------------------|------------|----------------|---------------------------|-------|-------|-------|------|-----------------|
| Threshold voltage | | Vsat | | 2.7 | 3.3 | 3.8 | V | Nota 1 |
| | | Vth | | 1.2 | 1.5 | 1.8 | V | INOLE I |
| | Harizantal | Left(9') | | - | 65 | - | Deg | * |
| Viewing Angle | Horizontai | Right(3') | CP > 10 | - | 65 | - | Deg | Not 2 |
| range | Vartical | Up(12') | CR > 10 | - | 45 | - | Deg | INOL 2 |
| | vertical | Down(6') | | - | 55 | - | Deg | • |
| Contrast ratio | | C/R | $\Theta = 0^{\circ}$ | - | 350 | - | | Not 3 |
| Transn | nittance | T(%) | $\Theta = 0^{\circ}$ | - | 5.5 | - | | Not 4 |
| White Chro | matiaity | X _w | $\Theta = 0_{\circ}$ | 0.302 | 0.322 | 0.342 | | |
| white Chro | maticity | y _w | | 0.323 | 0.343 | 0.362 | | * |
| | Dad | X _R | | 0.609 | 0.629 | 0.649 | | |
| | Reu | УR | | 0.321 | 0.341 | 0.361 | | Not 5 *Color |
| Reproductio | on Cross | X _G | $\Omega = \Omega^{\circ}$ | 0.291 | 0.311 | 0.331 | | Filter |
| Of color | Green | УG | $\Theta = 0_{\circ}$ | 0.549 | 0.569 | 0.589 | | Glass |
| | Dhaa | XB | | 0.121 | 0.141 | 0.161 | | • |
| | Blue | УB | | 0.094 | 0.114 | 0.134 | | |
| Respon | se Time | Tr+Tf | ⊖= 0° | | 30 | | smec | Not 6 |



Note :

1. The definition of Vth & Vsat



Figure 3. The definition of Vth & Vsat

2.Viewing angle is the angle at which the contrast ratio is greater than 10. The viewing are determined for the horizontal or 3, 9 o'clock direction and the vertical or 6, 12 o'clock direction with respect to the optical axis which is normal to the LCD surface.



Figure 4.Definition of viewing angle

3. Contrast measurements shall be made at viewing angle of $\Theta = 0^{\circ}$ and at the center of the LCD surface. Luminance shall be measured with all pixels in the view field set first to white, then to the dark (black) state.



 $CR = \frac{Luminance when displaying a white raster}{Luminance when displaying a black raster}$

4. Transmittance is the value with Polarizer.

5. The color chromaticity coordinates specified in Table 6. shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the C/F. Measurement condition is C - light source & Halogen Lamp.



Figure 5 Optical test equipment.

6. The electro-optical response time measurements shall be made as FIGURE 3 shown in Appendix by switching the "data" input signal ON and OFF. The times needed for the luminance to change from 10% to 90% is Tr, and 90% to 10% is Td







7 INTERFACE PIN CONNECTIONS

| • | T | | | | |
|-------|------------|-----------------------------------|-----------------|----------------|------------------|
| Pin | Definition | Description | 16bit Interface | 8bit Interface | Signal type (see |
| | | | | | from LCD) |
| 1 | GND | Ground | | | Ground |
| 2 | /CS_MAIN | LCD driver IC chip selection, | | | Input |
| | | active LOW | | | |
| 3 | RS | Command/Data | | | Input |
| 4 | /WR | LCD Write, active LOW | | | Input |
| 5 | /RD | LCD Read, active LOW | | | Input |
| 6-13 | DB[00: 07] | I CD data | Data[00: 07] | GND | Input/output |
| 14-21 | DB[08: 15] | | Data[08: 15] | Data[00: 07] | Input/output |
| 22 | IM0 | LCD interface selection | GND | IOVCC | Input |
| 23 | FLM | Frame head pulse signal | GPIO | GPIO | Output |
| 24 | / LCD_RST | LCD driver IC reset, active LOW | | | Input |
| 25 | GND | Ground | | | Ground |
| 26 | X+ | Touch panel X+ position | | | Output |
| 27 | Y+ | Touch panel Y+ position | | | Output |
| 28 | Х- | Touch panel X- position | | | Output |
| 29 | Y- | Touch panel Y- position | | | Output |
| 30 | GND | Ground | | | Ground |
| 31 | IOVCC | Interface I/O power supply (1.65V | | | Power |
| | | ~ 3.3V) | | | |
| 32 | VDD | Logic regulator power supply | | | Power |
| | | (2.5V ~ 3.3V) | | | |
| 33 | LED1+ | LED1 positive | | | Input |
| 34 | LED2+ | LED2 positive | | | Input |
| 35 | LED3+ | LED3 positive | | | Input |
| 36 | NC | NC | | | NC |
| 37 | NC | NC | | | NC |
| 38 | NC | NC | | | NC |
| 39 | LED- | LED- ground | | | Ground |

8 INITIALIZED CODE

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Please contact us for details (DRIVER IC: HX8340B : LCD: CMO 2.2").

9 SPECIFICATION OF QUALITY ASSURANCE

9.1 Summary

The customer should check and accept the products of FAIR within one month after reception.

This standard for Quality Assurance should affirm the quality of LCD products to supply to purchaser by FORMIKE CO.,LTD. Entire process is controlled according to QS9000.

9.2 Standard for quality test

(1) Inspection

Before delivering, the supplier should take the following tests, and affirm the quality of product.

(2) Electro-Optical Characteristics

According to the individual specification to test the product.

(3) Test of Appearance Characteristics:

According to the individual specification to test the product.

(4)Test of Reliability Characteristics

According to the definition of reliability on specification for test product.

(5) Delivery Test

Before delivering, the supplier should take the delivery test

(6)Sampling Method: GB/T2828.1-2003, Level II

(7) The defects classify of AQL as following

Major defect: AQL=0.65

Minor defect: AQL=1.5

9.3 Nonconforming Analysis & Deal With Manners

☆Nonconforming Analysis

(1) Purchaser should supply the detail data of nonconforming sample and the non-suitable state.

(2) After accepting the detail data from purchaser ,the analysis of nonconforming should be finished in two weeks.

(3) If supplier can not finish analysis on time ,must announce purchaser before two weeks.

 \Rightarrow Disposition of nonconforming

(1) If find any supplier defect during assembly line, supplier must change the good product for every defect after recognition.

(2) Both supplier and customer should analysis the reason and discuss the disposition of nonconforming when the reason of nonconforming is not sure.

9.4 Agreement items.

Both sides should discuss together when the following problems happen:

(1) There is any problem of standard of quality assurance ,and both sides think that must be modifier.

(2) There is any argument item which does not record in the quality assurance.

(3) Any other special problem.

9.5 Standard of the Product Appearance Test

9.5.1 Manner of appearance test

(1) The test must be under 20W*2 or 40W fluorescent light ,and the distance of view must be at 30 ± 5 cm.

(2) When test the model of Transmissive product must add the reflective plate.

(3) The test direction is base on about around 30 degree(within θ range) of vertical line.





- (4) Definition of Area:
 - A Area: Active area
 - B Area: Viewing area
 - C Area: Out of viewing area
 - D Area: Seal area



- 9.5.2 Basic principle:
- (1) It will accord to the AQL when the standard can not be described.
- (2) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (3) Must add new item on time when it is necessary.



9.6 Inspection specification

| NO | Item | Criterion | AQL | | | |
|----|--|--|---------------------------------|--|--|--|
| 01 | Electrical Testing | 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Contrast defect | | | | |
| 02 | LCD black spots, white spots, color spots, contamination, scratches (display/non-displa y) | 2.1Round type: As following drawing $\varphi=(x+y)/2$ \downarrow Y Size Acceptable QTY Rer $\varphi \le 0.20$ Ignore Ignore $0.20 < \varphi \le 2$ 3 No mor 0.25 2 3 No mor 0.25 2 3 No mor than tw $9 \le 0.3$ 1 2 within 0 $0.30 < \varphi$ 0 0 Total 3 5 2.2 Line Type: (As following drawing) \downarrow L \downarrow L \downarrow W VA | nark re 0 1.5 | | | |

FORMIKE ELECTRONIC CO., LTD

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| | | If bubbles are visit | ole, judge usin | g black spot specification, not | |
|----|-----------------------------|--|------------------------|---------------------------------------|-----|
| | | easy to find, must check in specify direction. | | | |
| | | cusy to find, must check in specify direction. | | | |
| | Dolorizor hubblog | Size | Accept | table QTY | |
| 02 | Polarizer bubbles | | A. A | V. A | 15 |
| 03 | Ignore | φ≦0.30 | Ignore | Ignore | 1.5 |
| | | $0.30 \le 0.60$ | 2 | 3 | |
| | | | 0 | 0 | |
| | | | , , | , , , , , , , , , , , , , , , , , , , | |
| | | | | | |
| | | Symbols: a: Chip length b: Chip width c: Chip thickness | | | |
| | | | | | |
| | | t: Glass thickness | | | |
| | | 4.1 ITO electrode | | | |
| | | b<=0.5mm | | | |
| | | c<=3.0mm | | | |
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| | | | | | |
| | | $ \rightarrow$ | | b a | |
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| | | *Effective width of seal area | a shall be more than (|).3mm. | |
| | 4.2 General ,corner portion | | | | |
| | | a<=t b<=0.5mm | | | |
| | | c<=3.0mm c | | | |
| | | | | | |
| | | | | | 1.5 |
| 04 | Chipped glass | | | | |
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| | | *Effective width of seal area shall be more than 0.3mm | | | |
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| 05 | Cracked glass | The LCD with extensive crack is not acceptable. | 0.65 |
|----|--------------------|---|------|
| 06 | Backlight elements | 6.1 Illumination source flickers when lit. | |
| | | 6.2 Spots or scratches that appear when lit must be judged | |
| | | using LCD spot, lines and contamination standards. | |
| | | 6.3 Backlight doesn't light or color is wrong | |
| | | | 0.65 |
| | Soldering | 7.1 No unmelted solder paste may be present on the PCB. | 1.5 |
| | | 7.2 No cold solder joints, missing solder connections, oxidation | |
| 07 | | or icicle. | 1.5 |
| 07 | | 7.3 No residue or solder balls on PCB. | |
| | | 7.4 No short circuits in components on PCB. | 1.5 |
| | | | 0.65 |
| | General appearance | 8.1 No oxidation, contamination, curves or, bends on interface | 1.5 |
| | | pin (OLB) of TCP. | |
| | | 8.2 No cracks on interface pin(OLB) of TCP | 0.65 |
| | | 8.3 NO contamination, solder residue or solder balls on | 1.5 |
| | | product. | |
| | | 8.4 The IC on the TCP may not be damaged, circuits. | 0.65 |
| | | 8.5 The residual rosin or tin oil of soldering (component or chip | 1.5 |
| | | component) is not burned into brown or black color. 8.6 | |
| | | Sealant on top of the ITO circuit has not hardened | 1.5 |
| 08 | | 8.7 Pin type must match type in specification sheet. | 0.65 |
| 08 | | 8.8 LCD pin loose or missing pins. | 0.65 |
| | | 8.9 Product packaging must the same as specified on packaging | 0.65 |
| | | specification sheet. | |
| | | 8.10 Product dimension and structure must conform to product | 0.65 |
| | | specification sheet. | |
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10 RELIABILITY

| NO | Test Item Description | | Test Condition |
|----|---|--|---|
| 1 | High temperature storage | Endurance test applying the high storage temperature for a long time | 70°С,240 Н |
| 2 | Low temperature storage | Endurance test applying the low storage temperature for a long time | -20°C,240H |
| 3 | High temperature operation | Endurance test applying the electric stress under high temperature for a long time | 60℃,96H |
| 4 | Low temperature operation | Endurance test applying the electric stress under low temperature for a long time | -10℃,96H |
| 5 | High temperature /humidity storage | Endurance test applying the high temperature and high humidity storage for a long time | 50℃, 90% R.H 240H |
| 6 | High temperature /humidity operation | Endurance test applying electric stress under high temperature and high humidity for a long time | 40℃ 90% R.H 96H |
| 7 | Temperature Cycle | Endurance test applying the low and high temperature cycle $-20^{\circ}C \rightarrow 25^{\circ}C \rightarrow 70^{\circ}C \rightarrow 25^{\circ}C$ 30min 5min 30min 5min one cycle | -20°C/70°C 10 cycles |
| 8 | Vibration test | Endurance test applying the vibration during transportation and using | 10Hz~50Hz Swing:0.75mm time:30min |
| 9 | Fall test | Endurance test dropping the LCM from a high place | 600mm height |
| 10 | Static electricity test | Endurance test applying static electric stress to terminal | Contact discharge: ±2KV~4KV Air discharge: ±2KV~10KV |

NOTE: TEST CONDITION

- (1) Temperature and humidity: If no specification, temp. set at $25\pm2^{\circ}$ C, humidity set at $60\pm5\%$ RH.
- (2) Operating state: Samples subject to the test shall be in "operating" condition.



11 PACKING

TBD